

## Features

- Wide Analog-Input-Voltage Range ..... 0V - 10V
- Low "ON" Resistance
  - $V_{CC} = 4.5V$  ..... 25Ω
  - $V_{CC} = 9V$  ..... 15Ω
- Fast Switching and Propagation Delay Times
- Low "OFF" Leakage Current
- Wide Operating Temperature Range ... -55°C to 125°C
- HC Types
  - 2V to 10V Operation
  - High Noise Immunity:  $N_{IL} = 30\%$ ,  $N_{IH} = 30\%$  of  $V_{CC}$  at  $V_{CC} = 5V$  and 10V
- HCT Types
  - Direct LSTTL Input Logic Compatibility,  $V_{IL} = 0.8V$  (Max),  $V_{IH} = 2V$  (Min)
  - CMOS Input Compatibility,  $I_I \leq 1\mu A$  at  $V_{OL}, V_{OH}$

## Description

The 'HC4066 and CD74HCT4066 contain four independent digitally controlled analog switches that use silicon-gate CMOS technology to achieve operating speeds similar to LSTTL with the low power consumption of standard CMOS integrated circuits.

These switches feature the characteristic linear "ON" resistance of the metal-gate CD4066B. Each switch is turned on by a high-level voltage on its control input.

## Ordering Information

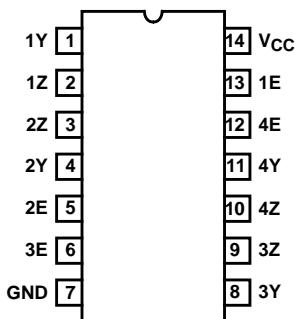
PART NUMBER	TEMP. RANGE (°C)	PACKAGE
CD54HC4066F3A	-55 to 125	14 Ld CERDIP
CD74HC4066E	-55 to 125	14 Ld PDIP
CD74HC4066M	-55 to 125	14 Ld SOIC
CD74HC4066MT	-55 to 125	14 Ld SOIC
CD74HC4066M96	-55 to 125	14 Ld SOIC
CD74HC4066PW	-55 to 125	14 Ld TSSOP
CD74HC4066PWR	-55 to 125	14 Ld TSSOP
CD74HC4066PWT	-55 to 125	14 Ld TSSOP
CD74HCT4066E	-55 to 125	14 Ld PDIP
CD74HCT4066M	-55 to 125	14 Ld SOIC
CD74HCT4066MT	-55 to 125	14 Ld SOIC
CD74HCT4066M96	-55 to 125	14 Ld SOIC

NOTE: When ordering, use the entire part number. The suffixes 96 and R denote tape and reel. The suffix T denotes a small-quantity reel of 250.

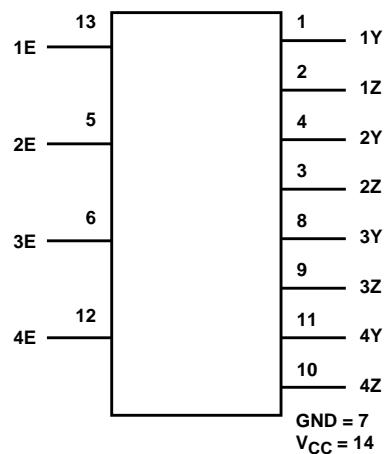
## Pinout

CD54HC4066 (CERDIP)  
 CD74HC4066 (PDIP, SOIC, TSSOP)  
 CD74HCT4066 (PDIP, SOIC)

TOP VIEW



### Functional Diagram



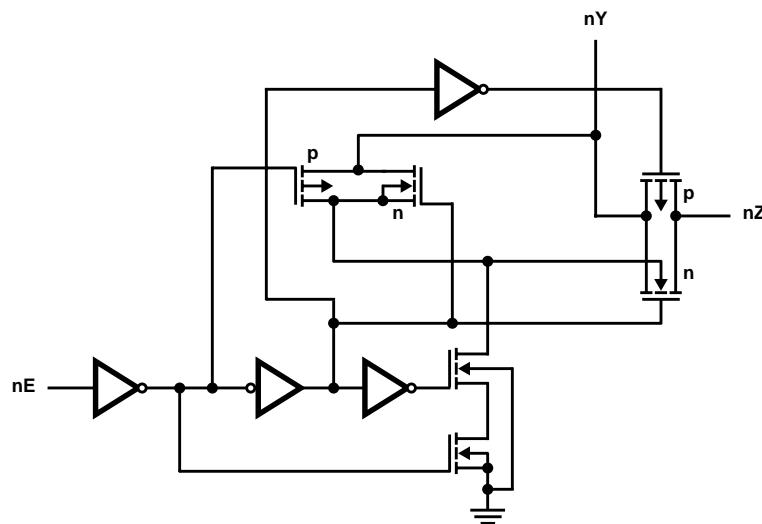
TRUTH TABLE

INPUT nE	SWITCH
L	Off
H	On

H= High Level  
L= Low Level

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### Logic Diagram



# CD54HC4066, CD74HC4066, CD74HCT4066

## Absolute Maximum Ratings

DC Supply Voltage, V <sub>CC</sub>	
HCT Types .....	-0.5V to 7V
HC Types .....	-0.5V to 10.5V
DC Input Diode Current, I <sub>IK</sub>	
For V <sub>I</sub> < -0.5V or V <sub>I</sub> > V <sub>CC</sub> + 0.5V .....	±20mA
DC Switch Current, I <sub>O</sub> (Note 1)	
For -0.5V < V <sub>O</sub> < V <sub>CC</sub> + 0.5V .....	±25mA
DC Output Diode Current, I <sub>OK</sub>	
For V <sub>O</sub> < -0.5V or V <sub>O</sub> > V <sub>CC</sub> + 0.5V .....	±20mA
DC Output Source or Sink Current per Output Pin, I <sub>O</sub>	
For V <sub>O</sub> > -0.5V or V <sub>O</sub> < V <sub>CC</sub> + 0.5V .....	±25mA
DC V <sub>CC</sub> or Ground Current, I <sub>CC</sub>	±50mA

## Thermal Information

Thermal Resistance (Typical, Note 2)	θ <sub>JA</sub>
E (PDIP) Package .....	80°C/W
M (SOIC) Package.....	86°C/W
PW (TSSOP) Package .....	113°C/W
Maximum Junction Temperature (Hermetic Package or Die) .....	175°C
Maximum Junction Temperature (Plastic Package) .....	150°C
Maximum Storage Temperature Range .....	-65°C to 150°C
Maximum Lead Temperature (Soldering 10s).....	300°C
(SOIC - Lead Tips Only)	

## Operating Conditions

Temperature Range, T <sub>A</sub> .....	-55°C to 125°C
Supply Voltage Range, V <sub>CC</sub>	
HC Types .....	.2V to 10V
HCT Types .....	.45V to 5.5V
DC Input or Output Voltage, V <sub>I</sub> , V <sub>O</sub> .....	0V to V <sub>CC</sub>
Input Rise and Fall Time	
2V .....	1000ns (Max)
4.5V.....	500ns (Max)
6V .....	400ns (Max)

**CAUTION:** Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

### NOTES:

1. In certain applications, the external load-resistor current may include both V<sub>CC</sub> and signal-line components. To avoid drawing V<sub>CC</sub> current when switch current flows into the transmission gate inputs, (terminals 1, 4, 8 and 11) the voltage drop across the bidirectional switch must not exceed 0.6V (calculated from R<sub>ON</sub> values shown in the DC Electrical Specifications Table). No V<sub>CC</sub> current will flow through R<sub>L</sub> if the switch current flows into terminals 2, 3, 9 and 10.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

## DC Electrical Specifications

PARAMETER	SYMBOL	TEST CONDITIONS		V <sub>CC</sub> (V)	25°C			-40°C TO 85°C		-55°C TO 125°C		UNITS
		V <sub>I</sub> (V)	V <sub>IS</sub> (V)		MIN	TYP	MAX	MIN	MAX	MIN	MAX	
<b>HC TYPES</b>												
High Level Input Voltage	V <sub>IH</sub>	-	-	2	1.5	-	-	1.5	-	1.5	-	V
				4.5	3.15	-	-	3.15	-	3.15	-	V
				9	6.3	-	-	6.3	-	6.3	-	V
Low Level Input Voltage	V <sub>IL</sub>	-	-	2	-	-	0.5	-	0.5	-	0.5	V
				4.5	-	-	1.35	-	1.35	-	1.35	V
				9	-	-	2.7	-	2.7	-	2.7	V
Input Leakage Current (Any Control)	I <sub>IL</sub>	V <sub>CC</sub> or GND	-	10	-	-	±0.1	-	±1	-	±1	µA
Off-Switch Leakage Current	I <sub>Z</sub>	V <sub>IL</sub>	V <sub>CC</sub> or GND	10	-	-	±0.1	-	±1	-	±1	µA

# CD54HC4066, CD74HC4066, CD74HCT4066

## DC Electrical Specifications (Continued)

PARAMETER	SYMBOL	TEST CONDITIONS		V <sub>CC</sub> (V)	25°C			-40°C TO 85°C		-55°C TO 125°C		UNITS
		V <sub>I</sub> (V)	V <sub>IS</sub> (V)		MIN	TYP	MAX	MIN	MAX	MIN	MAX	
"ON" Resistance I <sub>O</sub> = 1mA (Figure 1)	R <sub>ON</sub>	V <sub>CC</sub>	V <sub>CC</sub> or GND	4.5	-	25	80	-	106	-	128	Ω
				6	-	20	75	-	94	-	113	Ω
				9	-	15	60	-	78	-	95	Ω
			V <sub>CC</sub> to GND	4.5	-	35	95	-	118	-	142	Ω
				6	-	24	84	-	105	-	126	Ω
				9	-	16	70	-	88	-	105	Ω
		ΔR <sub>ON</sub>	V <sub>CC</sub>	4.5	-	1	-	-	-	-	-	Ω
				6	-	0.75	-	-	-	-	-	Ω
				9	-	0.5	-	-	-	-	-	Ω
Quiescent Device Current	I <sub>CC</sub>	V <sub>CC</sub> or GND	-	6	-	-	2	-	20	-	40	μA
				10	-	-	16	-	160	-	320	μA
<b>HCT TYPES</b>												
High Level Input Voltage	V <sub>IH</sub>	-	-	4.5 to 5.5	2	-	-	2	-	2	-	V
Low Level Input Voltage	V <sub>IL</sub>	-	-	4.5 to 5.5	-	-	0.8	-	0.8	-	0.8	V
Input Leakage Current (Any Control)	I <sub>IL</sub>	V <sub>CC</sub> or GND	-	5.5	-	-	±0.1	-	±1	-	±1	μA
Off-Switch Leakage Current	I <sub>Z</sub>	V <sub>IL</sub>	V <sub>CC</sub> or GND	5.5	-	-	±0.1	-	±1	-	±1	μA
"ON" Resistance I <sub>O</sub> = 1mA (Figure 1)	R <sub>ON</sub>	V <sub>CC</sub>	V <sub>CC</sub> or GND	4.5	-	25	80	-	106	-	128	Ω
				4.5	-	35	95	-	118	-	142	Ω
"ON" Resistance Between Any Two Switches	ΔR <sub>ON</sub>	V <sub>CC</sub>	-	4.5	-	1	-	-	-	-	-	Ω
Quiescent Device Current	I <sub>CC</sub>	V <sub>CC</sub> or GND	-	5.5	-	-	2	-	20	-	40	μA
Additional Quiescent Device Current Per Input Pin: 1 Unit Load	ΔI <sub>CC</sub> (Note 3)	V <sub>CC</sub> - 2.1	-	4.5 to 5.5	-	100	360	-	450	-	490	μA

NOTE:

- For dual-supply systems theoretical worst case (V<sub>I</sub> = 2.4V, V<sub>CC</sub> = 5.5V) specification is 1.8mA.

## HCT Input Loading Table

INPUT	UNIT LOADS
All	1

NOTE: Unit Load is ΔI<sub>CC</sub> limit specified in DC Electrical Specifications table, e.g., 360μA max at 25°C.

# CD54HC4066, CD74HC4066, CD74HCT4066

## Switching Specifications Input $t_r, t_f = 6\text{ns}$

PARAMETER	SYMBOL	TEST CONDITIONS	V <sub>CC</sub> (V)	25°C			-40°C TO 85°C		-55°C TO 125°C		UNITS
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
<b>HC TYPES</b>											
Propagation Delay Time Switch In to Out	t <sub>PLH</sub> , t <sub>PHL</sub>	C <sub>L</sub> = 50pF	2	-	-	60	-	75	-	90	ns
			4.5	-	-	12	-	15	-	18	ns
			9	-	-	8	-	11	-	13	ns
		C <sub>L</sub> = 15pF	5	-	4	-	-	-	-	-	ns
	t <sub>PZH</sub> , t <sub>PZL</sub>	C <sub>L</sub> = 50pF	2	-	-	100	-	125	-	150	ns
			4.5	-	-	20	-	25	-	30	ns
			9	-	-	12	-	15	-	18	ns
	t <sub>PHZ</sub> , t <sub>PLZ</sub>	C <sub>L</sub> = 50pF	5	-	8	-	-	-	-	-	ns
			2	-	-	150	-	190	-	225	ns
			4.5	-	-	30	-	38	-	45	ns
		C <sub>L</sub> = 15pF	9	-	-	24	-	30	-	36	ns
		5	-	12	-	-	-	-	-	ns	
Input (Control) Capacitance	C <sub>I</sub>	-	-	-	-	10	-	10	-	10	pF
Power Dissipation Capacitance (Notes 4, 5)	C <sub>PD</sub>	-	5	-	25	-	-	-	-	-	pF
<b>HCT TYPES</b>											
Propagation Delay Time Switch In to Out	t <sub>PLH</sub> , t <sub>PHL</sub>	C <sub>L</sub> = 50pF	4.5	-	-	12	-	15	-	18	ns
		C <sub>L</sub> = 15pF	5	-	4	-	-	-	-	-	ns
Propagation Delay Time Switch Turn On Delay	t <sub>PZH</sub> , t <sub>PZL</sub>	C <sub>L</sub> = 50pF	4.5	-	-	24	-	30	-	36	ns
		C <sub>L</sub> = 15pF	5	-	9	-	-	-	-	-	ns
Propagation Delay Time Switch Turn Off Delay	t <sub>PHZ</sub> , t <sub>PLZ</sub>	C <sub>L</sub> = 50pF	4.5	-	-	35	-	44	-	53	ns
		C <sub>L</sub> = 15pF	5	-	14	-	-	-	-	-	ns
Input (Control) Capacitance	C <sub>I</sub>	-	-	-	-	10	-	10	-	10	pF
Power Dissipation Capacitance (Notes 4, 5)	C <sub>PD</sub>	-	5	-	38	-	-	-	-	-	pF

### NOTES:

4. C<sub>PD</sub> is used to determine the dynamic power consumption, per package.
5. P<sub>D</sub> = C<sub>PD</sub> V<sub>CC</sub><sup>2</sup> f<sub>i</sub> + Σ (C<sub>L</sub> + C<sub>S</sub>) V<sub>CC</sub><sup>2</sup> f<sub>o</sub> where f<sub>i</sub> = input frequency, f<sub>o</sub> = output frequency, C<sub>L</sub> = output load capacitance, C<sub>S</sub> = switch capacitance, V<sub>CC</sub> = supply voltage.

## Analog Channel Specifications T<sub>A</sub> = 25°C

PARAMETER	TEST CONDITIONS	V <sub>CC</sub> (V)	HC4066	CD74HCT4066	UNITS
Switch Frequency Response Bandwidth at -3dB Figure 2	Figure 5, Notes 6, 7	4.5	200	200	MHz
Cross Talk Between Any Two Switches Figure 3	Figure 4, Notes 7, 8	4.5	-72	-72	dB
Total Harmonic Distortion	Figure 6, 1kHz, V <sub>IS</sub> = 4V <sub>P-P</sub>	4.5	0.022	0.023	%
	Figure 6, 1kHz, V <sub>IS</sub> = 8V <sub>P-P</sub>	9	0.008	N/A	%

# CD54HC4066, CD74HC4066, CD74HCT4066

## Analog Channel Specifications $T_A = 25^\circ\text{C}$ (Continued)

PARAMETER	TEST CONDITIONS	V <sub>CC</sub> (V)	HC4066	CD74HCT4066	UNITS
Control to Switch Feedthrough Noise	Figure 7	4.5	200	130	mV
		9	550	N/A	mV
Switch "OFF" Signal Feedthrough Figure 3	Figure 8, Notes 7, 8	4.5	-72	-72	dB
Switch Input Capacitance, C <sub>S</sub>		-	5	5	pF

### NOTES:

6. Adjust input level for 0dBm at output, f = 1MHz.
7. V<sub>IS</sub> is centered at V<sub>CC</sub>/2.
8. Adjust input for 0dBm at V<sub>IS</sub>.

## Typical Performance Curves

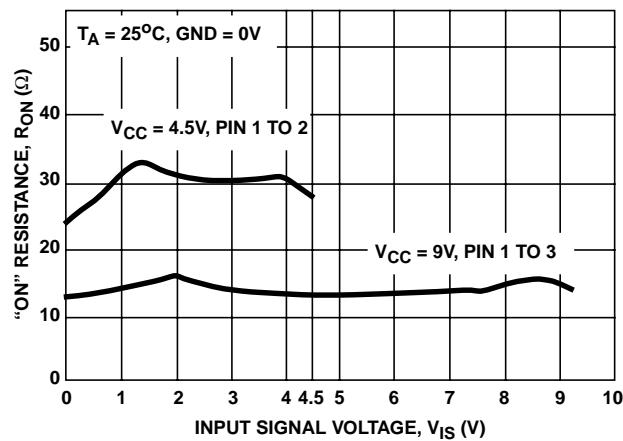


FIGURE 1. TYPICAL "ON" RESISTANCE vs INPUT SIGNAL VOLTAGE

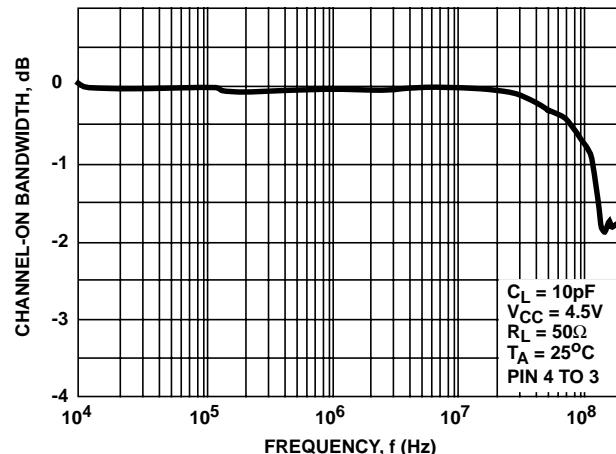


FIGURE 2. SWITCH FREQUENCY RESPONSE, V<sub>CC</sub> = 4.5V

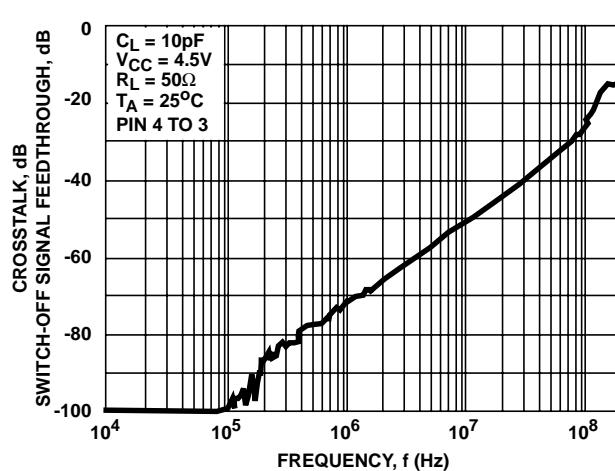


FIGURE 3. SWITCH-OFF SIGNAL FEEDTHROUGH AND CROSSTALK vs FREQUENCY, V<sub>CC</sub> = 4.5V

### Analog Test Circuits

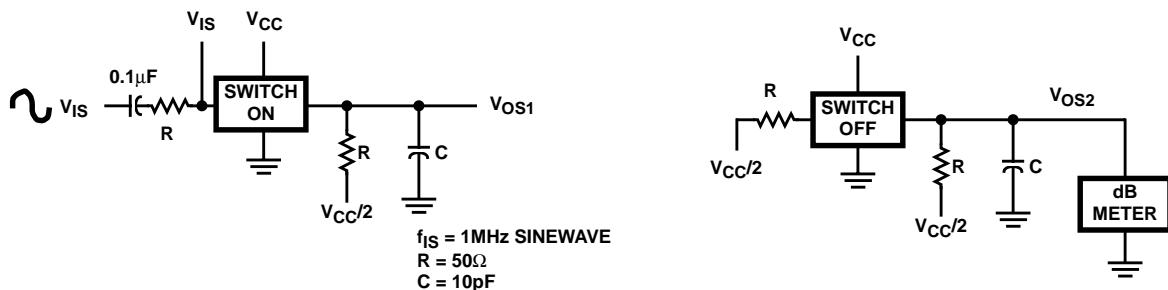


FIGURE 4. CROSSTALK BETWEEN TWO SWITCHES TEST CIRCUIT

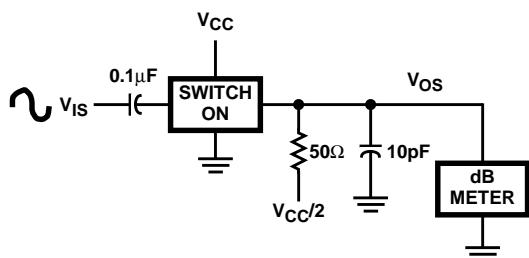


FIGURE 5. FREQUENCY RESPONSE TEST CIRCUIT

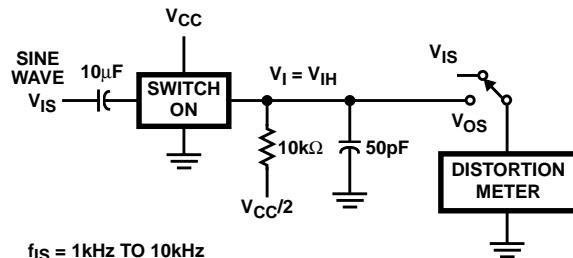


FIGURE 6. TOTAL HARMONIC DISTORTION TEST CIRCUIT

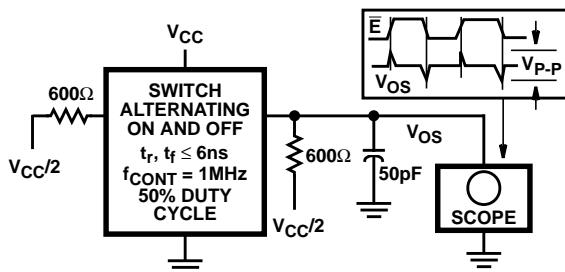


FIGURE 7. CONTROL-TO-SWITCH FEEDTHROUGH NOISE TEST CIRCUIT

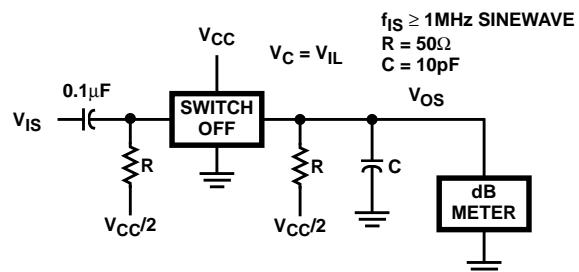


FIGURE 8. SWITCH OFF SIGNAL FEEDTHROUGH

### Test Circuits and Waveforms

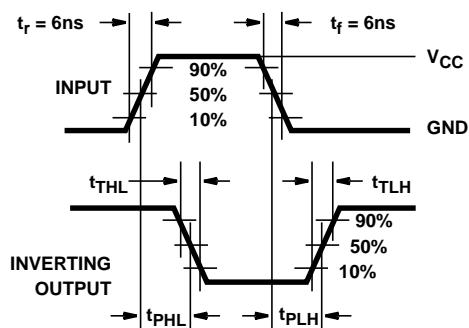


FIGURE 9. HC TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC

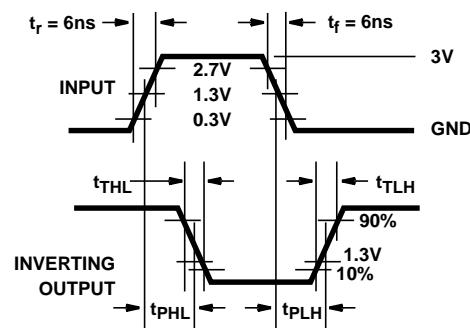
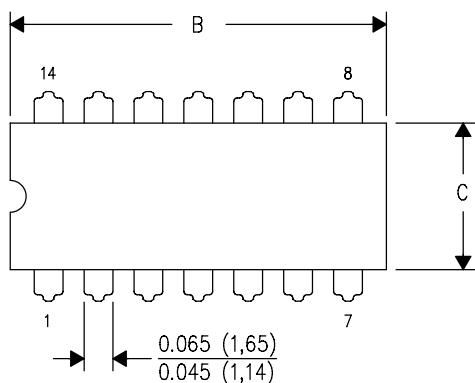


FIGURE 10. HCT TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC

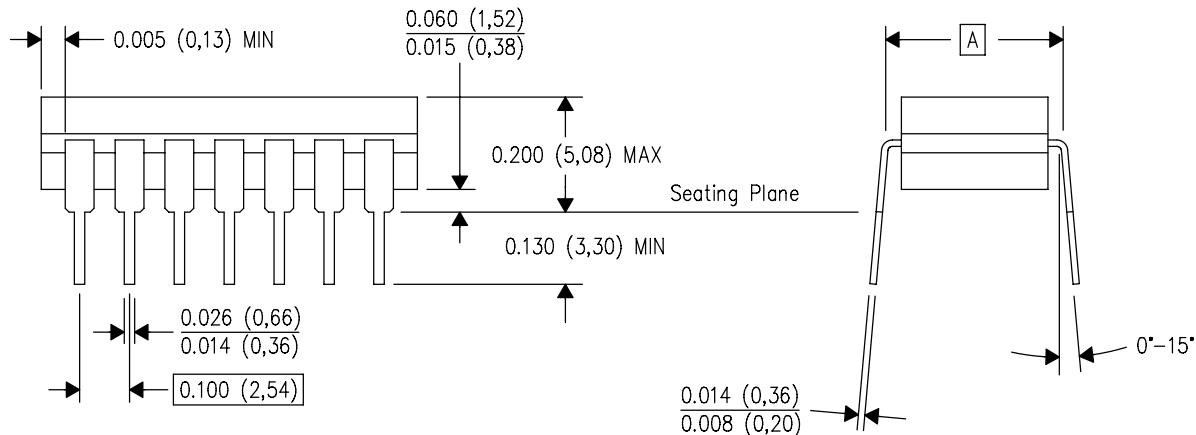
J (R-GDIP-T\*\*)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



PINS **\nDIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

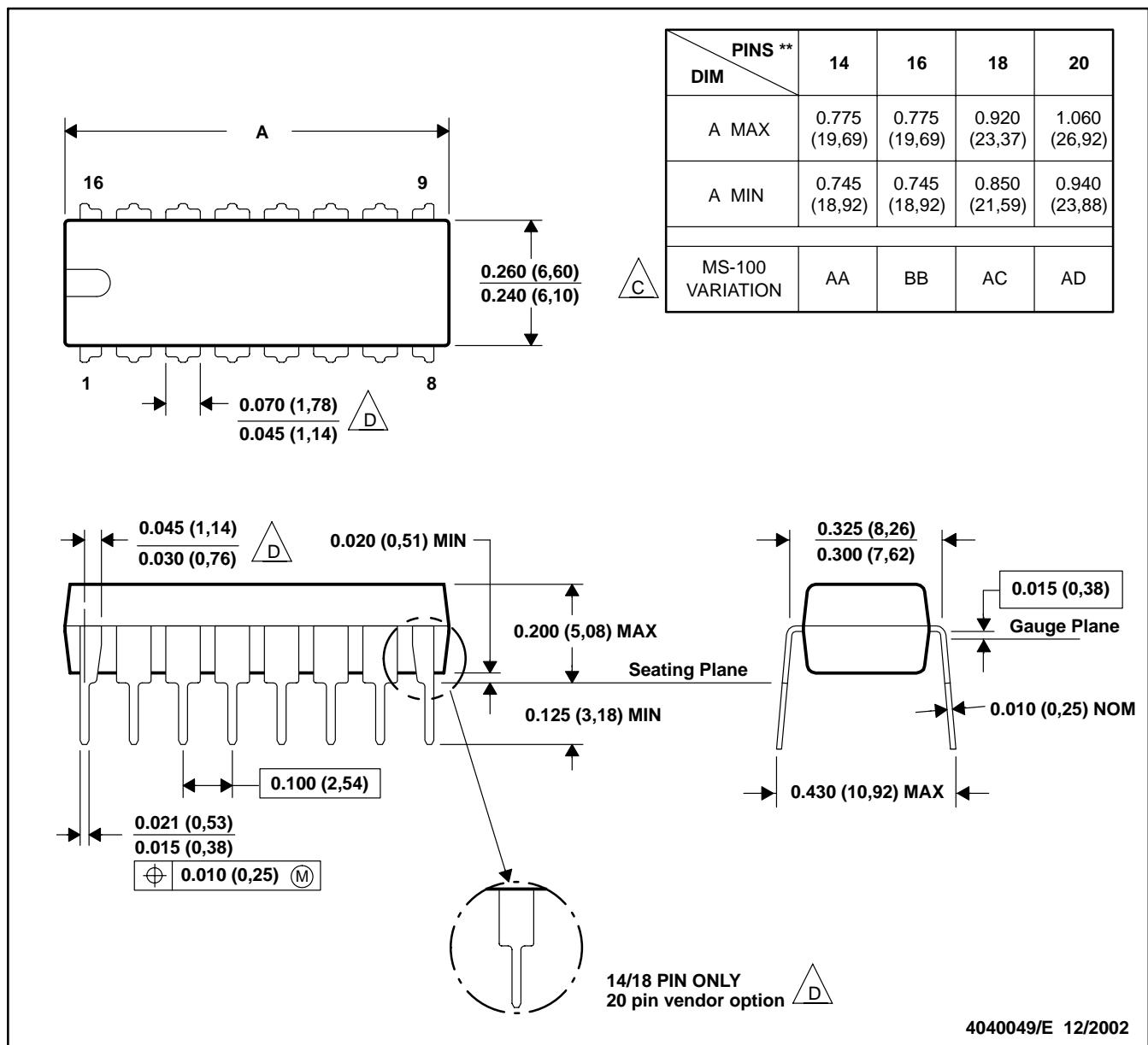
# MECHANICAL

MPDI002C – JANUARY 1995 – REVISED DECEMBER 20002

N (R-PDIP-T\*\*)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

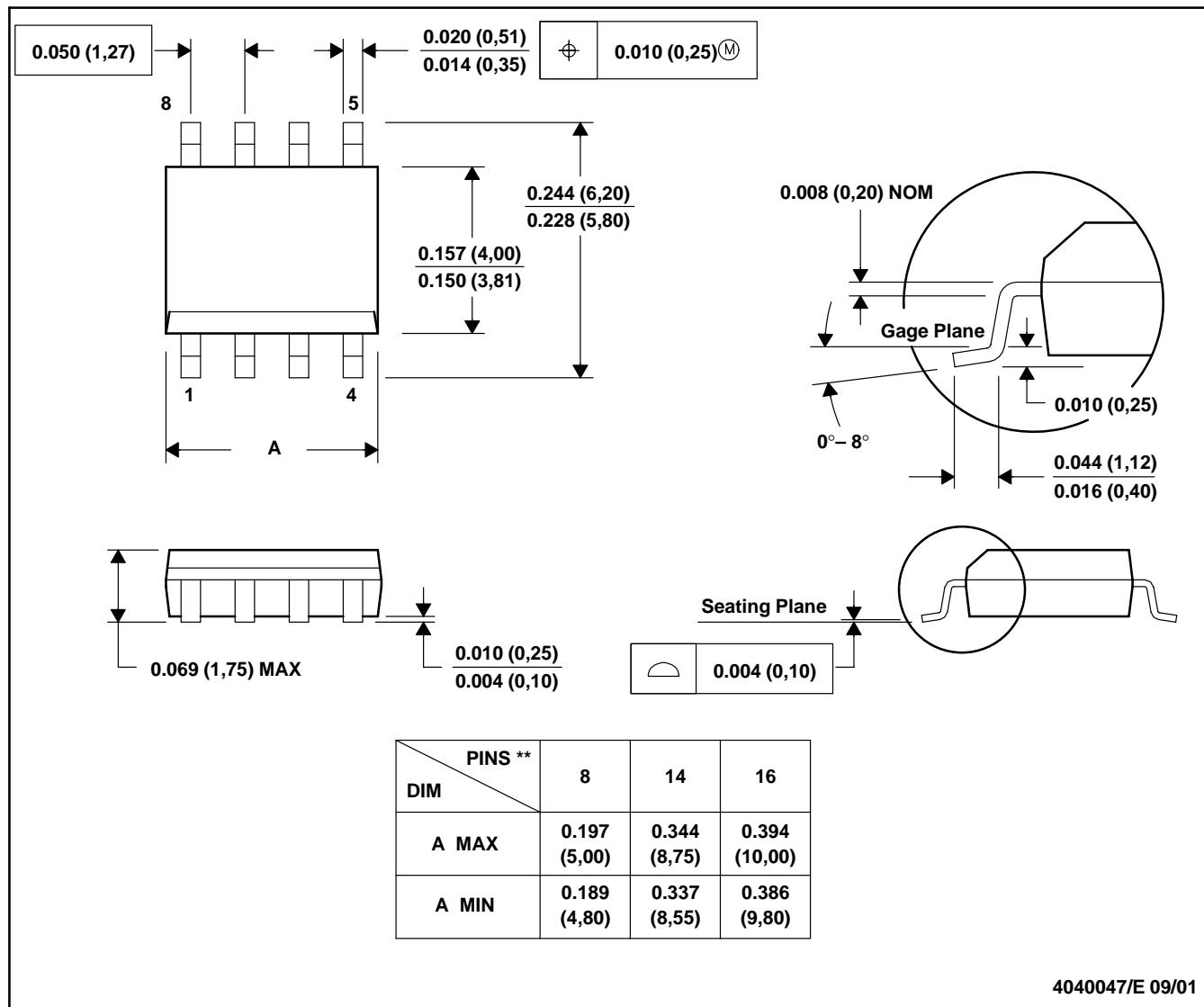
C. Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

## D (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



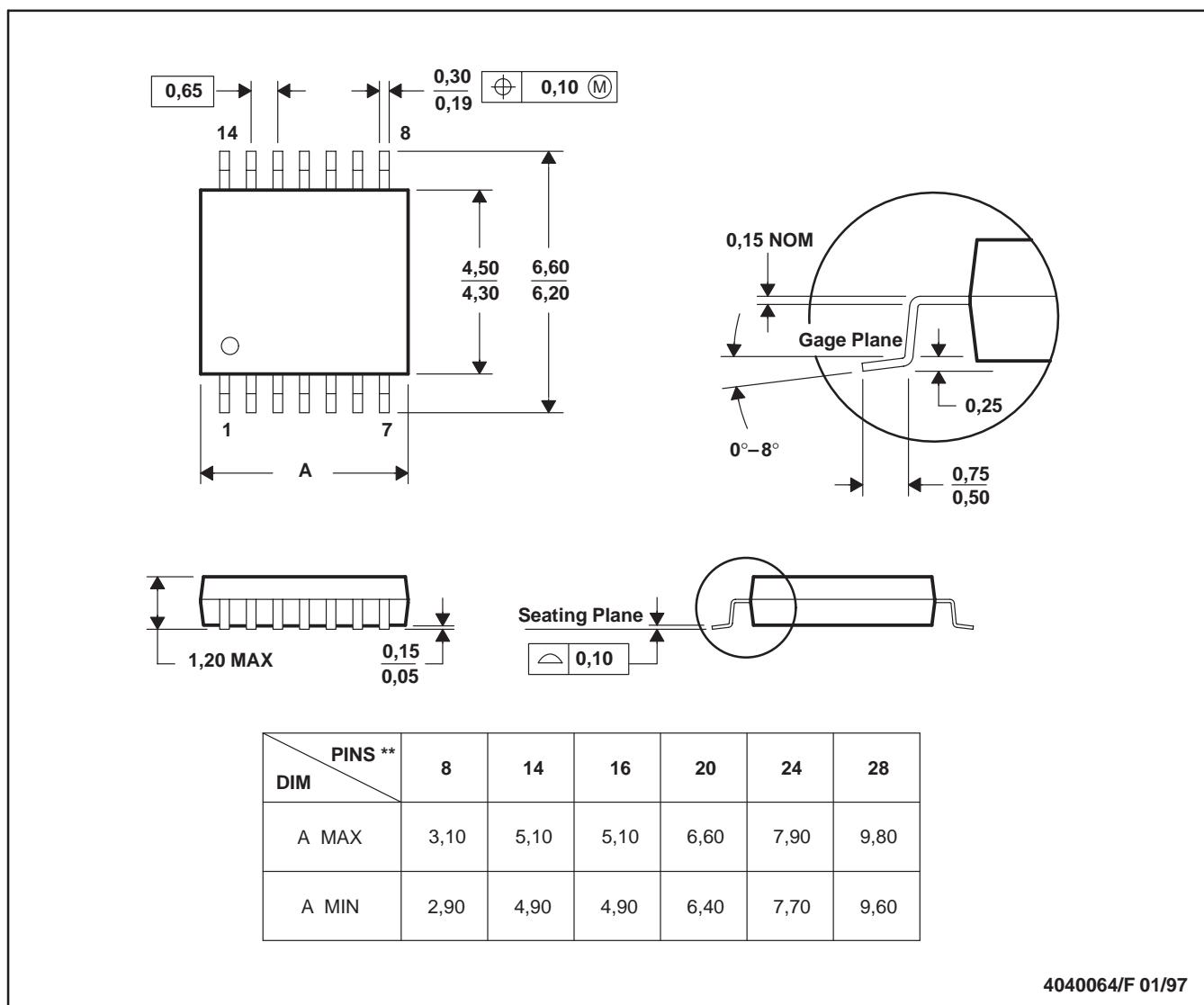
4040047/E 09/01

- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0.15).  
 D. Falls within JEDEC MS-012

## PW (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion not to exceed 0,15.
  - Falls within JEDEC MO-153

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